

REVISIONS

LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Make change to the vendor part number from ISL3298EMRTEP-T/-TK to ISL3298EMRTEP-TK. Update document paragraphs to current requirements. - ro	17-04-10	C. SAFFLE
B	Update document paragraphs to current requirements. - ro	22-06-02	J. ESCHMEYER



**CURRENT DESIGN ACTIVITY CAGE CODE 16236
HAS CHANGED NAMES TO
DLA LAND AND MARITIME
COLUMBUS, OHIO 43218-3990**

Prepared in accordance with ASME Y14.24

Vendor Item Drawing

Revision Status of Sheets

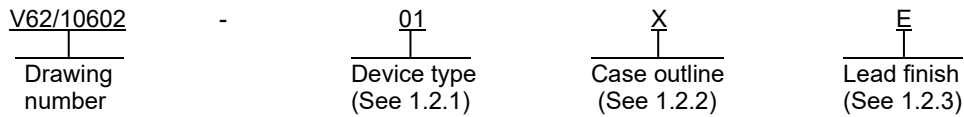
REV																				
SHEET																				
REV	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B	B				
SHEET	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16				

PMIC N/A Original date of drawing YY-MM-DD 10-03-24	PREPARED BY RAJESH PITHADIA		DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990 https://www.dla.mil/landandmaritime	
	CHECKED BY RAJESH PITHADIA		TITLE MICROCIRCUIT, LINEAR, LOW POWER, RS-485/RS-422 TRANSMITTER, MONOLITHIC SILICON	
	APPROVED BY CHARLES F. SAFFLE		DWG NO. V62/10602	
	SIZE A	CAGE CODE 16236	PAGE 1 OF 16	
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1. SCOPE

1.1 Scope. This drawing documents the general requirements of a high performance low power, RS-485/RS-422 transmitter microcircuit, with an operating temperature range of -55°C to +125°C.

1.2 Vendor Item Drawing Administrative Control Number. The manufacturer's PIN is the item of identification. The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation:



1.2.1 Device type(s).

<u>Device type</u>	<u>Generic</u>	<u>Circuit function</u>
01	ISL3298E	Low power, RS-485/RS-422 transmitter

1.2.2 Case outline(s). The case outline(s) are as specified herein.

<u>Outline letter</u>	<u>Number of pins</u>	<u>JEDEC PUB 95</u>	<u>Package style</u>
X	8	See figure 1	Thin dual flat leadless plastic package

1.2.3 Lead finishes. The lead finishes are as specified below or other lead finishes as provided by the device manufacturer:

<u>Finish designator</u>	<u>Material</u>
A	Hot solder dip
B	Tin-lead plate
C	Gold plate
D	Palladium
E	Gold flash palladium
F	Tin-lead alloy (BGA/CGA)
Z	Other

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1.3 Absolute maximum ratings. 1/

VCC to GND	-0.3 V to 7 V
VL to GND	-0.3 V to VCC + 0.3 V
Input voltages:	
Pins DI, DE	-0.3 V to 7 V
Output voltages:	
Pins Y, Z (VCC ≤ 3.6 V)	-8 V to +13 V
Pins Y, Z (VCC > 3.6 V)	-0.5 V to VCC + 0.5 V
Short circuit duration:	
Pins Y, Z (VCC ≤ 3.6 V)	Continuous
Pins Y, Z (VCC > 3.6 V) <u>2/</u>	1 second at < 300 mA
ESD rating	See table I
Junction temperature range (TJ)	150°C
Storage temperature range (TSTG)	-65°C to 150°C
Thermal resistance, junction to case (θJC): <u>3/ 4/</u>	
X package	8°C/W
Thermal resistance, junction to ambient (θJA): <u>3/ 4/</u>	
X package	65°C/W

1.4 Recommended operating conditions. 5/

Operating free-air temperature range (TA)	-55°C to +125°C
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1/ Stresses beyond those listed under “absolute maximum rating” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2/ Due to the high short circuit current at VCC > 3.6 V, the outputs must not be shorted outside the range of GND to VCC or damage may occur. To prevent excessive power dissipation that may damage the output, the short circuit current should be limited to ≤ 300 mA during testing. It is best to use an external resistor for this purpose, since the current limiting on the VO supply may respond too slowly to protect the output.

3/ θJA is measured in free air with the component mounted on a high effective thermal conductivity test board with “direct attach” features. See manufacturer’s technical brief TB379.

4/ For θJC, the “case temp” location is the center of the exposed metal pad on the package underside.

5/ Use of this product beyond the manufacturers design rules or stated parameters is done at the user’s risk. The manufacturer and/or distributor maintain no responsibility or liability for product used beyond the stated limits.

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2. APPLICABLE DOCUMENTS

DEPARTMENT OF DEFENSE STANDARDS

- MIL-STD-883 – Test Method Standard Microcircuits.
- Method 3015 – Electrostatic discharge sensitivity classification

(Copies of these documents are available online at <https://quicksearch.dla.mil>.)

INTERNATIONAL ELECTROTECHNICAL COMMISSION (IEC)

- IEC 61000-4-2 – Electromagnetic Compatibility (EMC) – Part 4-2
Testing and Measurement Techniques – Electrostatic Discharge Immunity Test

(Copies of these documents are available online at <https://www.iec.ch>.)

JEDEC Solid State Technology Association

- JEDEC PUB 95 – Registered and Standard Outlines for Semiconductor Devices

(Copies of these documents are available online at <https://www.jedec.org>.)

3. REQUIREMENTS

3.1 Marking. Parts shall be permanently and legibly marked with the manufacturer’s part number as shown in 6.3 herein and as follows:

- A. Manufacturer’s name, CAGE code, or logo
- B. Pin 1 identifier
- C. ESDS identification (optional)

3.2 Unit container. The unit container shall be marked with the manufacturer’s part number and with items A and C (if applicable) above.

3.3 Electrical characteristics. The maximum and recommended operating conditions and electrical performance characteristics are as specified in 1.3, 1.4, and table I herein.

3.4 Design, construction, and physical dimension. The design, construction, and physical dimensions are as specified herein.

3.5 Diagrams.

3.5.1 Case outline. The case outline shall be as shown in 1.2.2 and figure 1.

3.5.2 Terminal connections. The terminal connections shall be as shown in figure 2.

3.5.3 Truth table. The truth table shall be as shown in figure 3.

3.5.4 Timing waveforms and test circuit. The timing waveforms and test circuit shall be as shown in figures 4, 5, 6, and 7.

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TABLE I. Electrical performance characteristics. 1/

Test	Symbol	Conditions 2/	Temperature, T _A	Device type	Limits 3/ 4/		Unit
					Min	Max	
DC characteristics							
Driver differential V _{OUT}	V _{OD}	RL = 100 Ω (RS-422), V _{CC} ≥ 3.15 V, See figure 4 circuit A	-55°C to +125°C	01	2		V
		RL = 100 Ω (RS-422), V _{CC} ≥ 4.5 V, See figure 4 circuit A			3		V
		RL = 54 Ω (RS-485), V _{CC} ≥ 3.0 V, See figure 4 circuit A			1.5	V _{CC}	V
		RL = 54 Ω (RS-485), V _{CC} ≥ 4.5 V, See figure 4 circuit A			2.5	V _{CC}	V
		No load				V _{CC}	V
		RL = 60 Ω, -7 V ≤ V _{CM} ≤ 12 V, See figure 4 circuit B			1.5		V
Change in magnitude of driver differential V _{OUT} for complementary output states	ΔV _{OD}	RL = 54 Ω or 100 Ω, See figure 4 circuit A	-55°C to +125°C	01		0.2	V
Driver common-mode V _{OUT}	V _{OC}	RL = 54 Ω or 100 Ω, V _{CC} ≤ 3.6 V See figure 4 circuit A	-55°C to +125°C	01		3	V
		RL = 54 Ω or 100 Ω, V _{CC} ≤ 5.5 V See figure 4 circuit A				3.2	
Change in magnitude of driver common-mode V _{OUT} for complementary output states	ΔV _{OC}	RL = 54 Ω or 100 Ω, See figure 4 circuit A	-55°C to +125°C	01		0.2	V
Input high voltage (DI, DE)	V _{IH1}	V _L = V _{CC} , V _{CC} ≤ 3.6 V	-55°C to +125°C	01	2.2		V
	V _{IH2}	V _L = V _{CC} , V _{CC} ≤ 5.5 V			3		
	V _{IH3}	2.7 V ≤ V _L < 3.0 V			2		
	V _{IH4}	2.3 V ≤ V _L < 2.7 V			1.65		
	V _{IH5}	1.6 V ≤ V _L < 2.3 V			0.7*V _L		
	V _{IH6}	1.35 V ≤ V _L < 1.6 V	+25°C	0.5*V _L typical			

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued. 1/

Test	Symbol	Conditions <u>2/</u>	Temperature, TA	Device type	Limits <u>3/ 4/</u>		Unit
					Min	Max	
DC characteristics – continued.							
Input low voltage (DI, DE)	VIL1	VL = VCC	-55°C to +125°C	01		0.8	V
	VIL2	VL ≥ 2.7 V				0.8	
	VIL3	2.3 V ≤ VL < 2.7 V				0.65	
	VIL4	1.6 V ≤ VL < 2.3 V				0.22*VL	
	VIL5	1.35 V ≤ VL < 1.6 V	-55°C to +125°C		0.3*VL typical		
Logic input current	IIN	DI = DE = 0 V or VCC <u>5/</u>	-55°C to +125°C	01	-2	2	µA
Output leakage current (Y, Z) <u>5/</u>	IOZ	DE = 0 V, VCC = 0 V, 3.6 V, or 5.5 V, VIN = 12 V	-55°C to +125°C	01		40	µA
		DE = 0 V, VCC = 0 V, 3.6 V, or 5.5 V, VIN = -7 V			-40		
Driver short circuit current, Vo = High or Low <u>6/</u>	IOSD1	DE = VCC, -7 V ≤ Vo ≤ 12 V, VCC ≤ 3.6 V	-55°C to +125°C	01		±250	mA
		DE = VCC, 0 V ≤ Vo ≤ VCC, VCC > 3.6 V <u>7/</u>				±450	
Thermal shutdown threshold	TSD		-55°C to +125°C	01	160 typical		°C
Supply current							
No load supply current	ICC	DI = 0 V or VCC, DE = VCC	-55°C to +125°C	01		150	µA
Shutdown supply current	ISHDN	DE = 0 V, DI = 0 V or VCC	-55°C to +125°C	01		1	µA
ESD performance							
RS-485 pins (Y, Z)		Human body model, from bus pins to GND	+25°C	01	±16.5 typical		kV
		IEC61000 contact, from bus pins to GND			±7 typical		
All pins		Human body model, per MIL-STD-883 method 3015			±8 typical		V
		Machine model			±400 typical		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued. 1/

Test	Symbol	Conditions 2/	Temperature, TA	Device type	Limits 3/ 4/		Unit
					Min	Max	
Driver switching characteristics							
Maximum data rate	fMAX	VOD = ±1.5 V, CD = 360 pF, See figure 5	-55°C to +125°C	01	16		Mbps
Driver single ended output delay	tSD	RDIFF = 54 Ω, CD = 50 pF, VL = VCC, see figure 6	-55°C to +125°C	01	15	42	ns
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.8 V, see figure 6	+25°C		32 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.5 V, see figure 6			36 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.35 V, see figure 6			40 typical		
Part-to-part output delay skew	tsKPP	RDIFF = 54 Ω, CD = 50 pF, see figure 6 8/	-55°C to +125°C	01		25	ns
Driver single ended output skew	tSSK	RDIFF = 54 Ω, CD = 50 pF, VL = VCC, see figure 6	-55°C to +125°C	01		7	ns
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.8 V, see figure 6	+25°C		3 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.5 V, see figure 6			4 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.35 V, see figure 6			5 typical		
Driver differential output delay	tDD	RDIFF = 54 Ω, CD = 50 pF, VL = VCC, see figure 6	-55°C to +125°C	01		42	ns
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.8 V, see figure 6	+25°C		32 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.5 V, see figure 6			36 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.35 V, see figure 6			42 typical		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued. 1/

Test	Symbol	Conditions 2/	Temperature, TA	Device type	Limits 3/ 4/		Unit
					Min	Max	
Driver switching characteristic – continued.							
Driver differential output skew	tDSK	RDIFF = 54 Ω, CD = 50 pF, VL = VCC ≤ 3.6 V, see figure 6	-55°C to +125°C	01		3	ns
		RDIFF = 54 Ω, CD = 50 pF, VL = VCC = 5 V, see figure 6	+25°C		2 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.8 V, VCC = 3.3 V, see figure 6			0.5 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.8 V, VCC = 5 V, see figure 6			1 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.5 V, VCC = 3.3 V, see figure 6			1 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.5 V, VCC = 5 V, see figure 6			2 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.35 V, VCC = 3.3 V, see figure 6			2 typical		
		RDIFF = 54 Ω, CD = 50 pF, VL = 1.35 V, VCC = 5 V, see figure 6			4 typical		
Driver differential rise or fall time	tR, tF	RDIFF = 54 Ω, CD = 50 pF, VL = VCC, see figure 6	-55°C to +125°C	01		15	ns
		RDIFF = 54 Ω, CD = 50 pF, VL ≥ 1.35 V, see figure 6	+25°C		9 typical		
Driver enable to output high	tzH	RL = 500 Ω, CL = 50 pF, SW = GND, see figure 7	-55°C to +125°C	01		250	ns
Driver enable to output low	tzL	RL = 500 Ω, CL = 50 pF, SW = VCC, see figure 7	-55°C to +125°C	01		250	ns

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued. 1/

Test	Symbol	Conditions <u>2/</u>	Temperature, T _A	Device type	Limits <u>3/ 4/</u>		Unit
					Min	Max	
Driver switching characteristic – conti nued.							
Driver disable from output high	tHZ	R _L = 500 Ω, C _L = 50 pF, SW = GND, see figure 7	-55°C to +125°C	01		60	ns
Driver disable from output low	tLZ	R _L = 500 Ω, C _L = 50 pF, SW = VCC, see figure 7	-55°C to +125°C	01		60	ns

1/ Testing and other quality control techniques are used to the extent deemed necessary to assure product performance over the specified temperature range. Product may not necessarily be tested across the full temperature range and all parameters may not necessarily be tested. In the absence of specific parametric testing, product performance is assured by characterization and/or design.

2/ Unless otherwise specified, V_{CC} = 3.0 V to 5.5 V, V_L = V_{CC}. Typical values are at T_A = +25°C. All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground.

3/ Parts are 100% tested at +25°C. Over-temperature limits established by characterization and are not production tested.

4/ Typicals are measured at V_{CC} = 3.3 V for parameters specified with 3 V ≤ V_{CC} ≤ 3.6 V, and are measured at V_{CC} = 5 V for parameters specified with 4.5 V ≤ V_{CC} ≤ 5.5 V. If V_{CC} isn't specified, then a single "typical" entry applies to both V_{CC} = 3.3 V and 5 V.

5/ If the driver enable function isn't needed, connect DE to V_{CC} (or V_L) through a 1 kΩ to 3 kΩ resistor.

6/ Applies to peak current.

7/ Due to the high short circuit current at V_{CC} >3.6 V, the outputs must not be shorted outside the range of GND to V_{CC} or damage may occur. To prevent excessive power dissipation that may damage the output, the short circuit current should be limited to ≤ 300 mA during testing. It is best to use an external resistor for this purpose, since the current limiting on the V_O supply may respond too slowly to protect the output.

8/ tSKPP is the magnitude of the difference in propagation delays of the specified terminals of two units tested with identical test conditions (V_{CC}, temperature, etc.).

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Case X

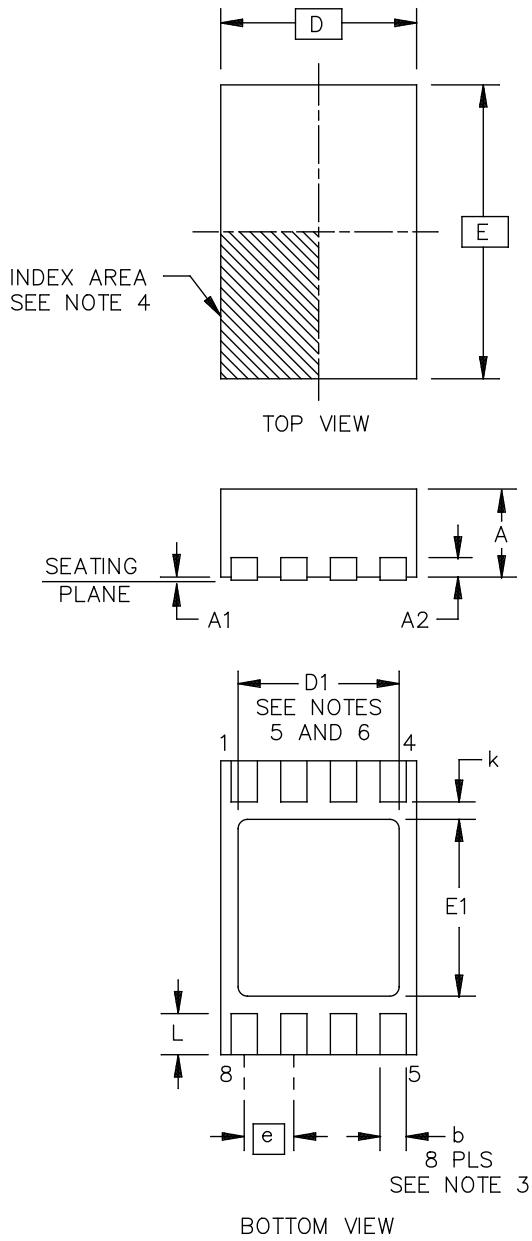


FIGURE 1. Case outline.

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Case X – continued.

Symbol	Dimensions				Notes
	Inches		Millimeters		
	Min	Max	Min	Max	
A	.027	.031	0.70	0.80	----
A1	----	.001	----	0.05	----
A2	.007 REF		0.20 REF		----
b	.007	.012	0.20	0.32	3, 6
D	.078 BSC		2.00 BSC		----
D1	.059	.068	1.50	1.75	5, 6
E	.118 BSC		3.00 BSC		----
E1	.064	.074	1.65	1.90	5, 6
e	.019 BSC		0.50 BSC		----
k	.007	----	0.20	----	----
L	.011	.019	0.30	0.50	6
N	8		8		7

NOTES:

1. Controlling dimensions are millimeter, inch dimensions are given for reference only.
2. Dimensioning and tolerancing conform to ASME Y14.5-1994.
3. Dimension b applies to the metalized terminal and is measured between 0.25 mm and 0.30 mm from the terminal tip.
4. The configuration of the pin number 1 identifier is optional, but must be located within the zone indicated. the pin number 1 identifier may be either a mold or mark feature.
5. Dimesions D1 and E1 are for the exposed pads which provide improved electrical and thermal performance.
6. Nominal dimensions are provided to assist with printed circuit board land pattern design efforts, see manufacturer's technical brief TB389.
7. N is the number of terminals.

FIGURE 1. Case outline – Continued.

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Device type	01
Case outlines	X
Terminal number	Terminal symbol
1	VL
2	DE
3	DI
4	GND
5	GND
6	Y
7	Z
8	VCC

Terminal symbol	Description
DE	Driver output enable. The driver outputs, Y and Z, are enabled by bringing DE high, and are high impedance when DE is low. If the driver enable function isn't needed, connect DE to VCC (or VL) through a 1 k Ω to 3 k Ω resistor.
DI	Driver input. A low on DI forces output Y low and output Z high. Similarly, a high on DI forces output Y high and output Z low.
GND	Ground connection. This is also the potential of the thin dual flat leadless package thermal pad.
Y	± 15 kV human body model, ± 7 kV IEC61000 (contact method) ESD Protected RS-485/422 level, noninverting transmitter output.
Z	± 15 kV human body model, ± 7 kV IEC61000 (contact method) ESD Protected RS-485/422 level, inverting transmitter output.
VCC	System power supply input (3.0 V to 5.5 V). On devices with a VL pin, power-up VCC first.
VL	Logic-level supply which sets the V _{IL} /V _{IH} levels for the DI and DE pins. Power-up this supply after VCC, and keep VL \leq VCC.

FIGURE 2. Terminal connections.

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Inputs		Output	
DE (see note 1)	DI	Z	Y
1	1	0	1
1	0	1	0
0	X	High-Z (see note 2)	High-Z (see note 2)

X = Don't care

NOTES:

1. If the driver enable function isn't needed, connect DE to VCC (or VL) through a 1 kΩ to 3 kΩ resistor.
2. Shutdown mode.

FIGURE 3. Truth table.

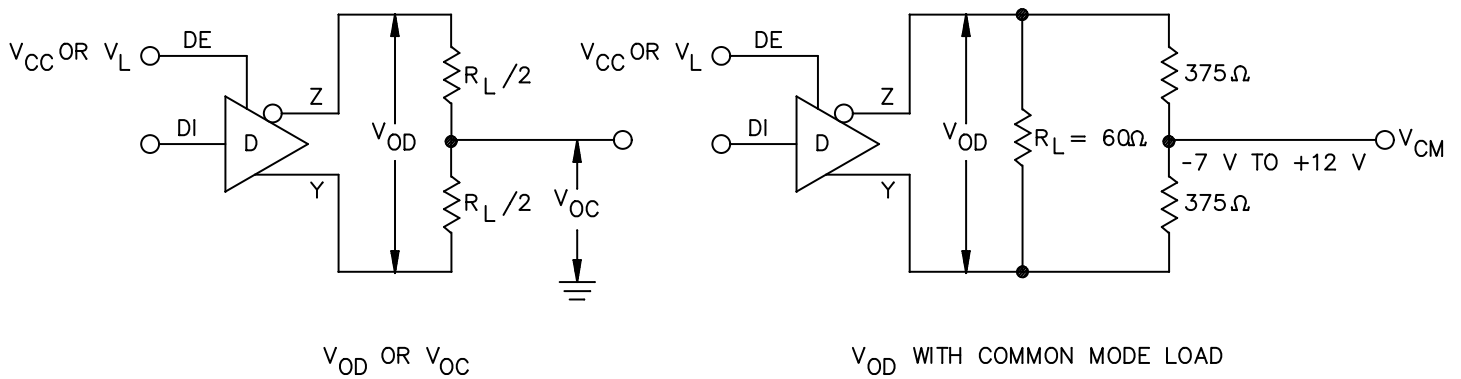


FIGURE 4. DC driver test circuits.

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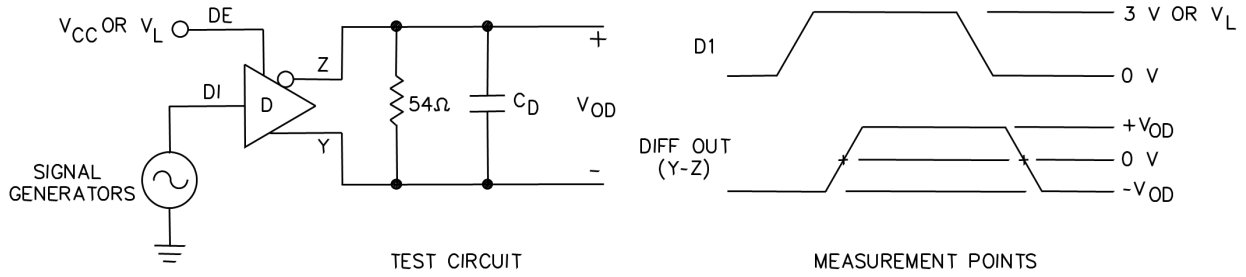


FIGURE 5. Driver data rate.

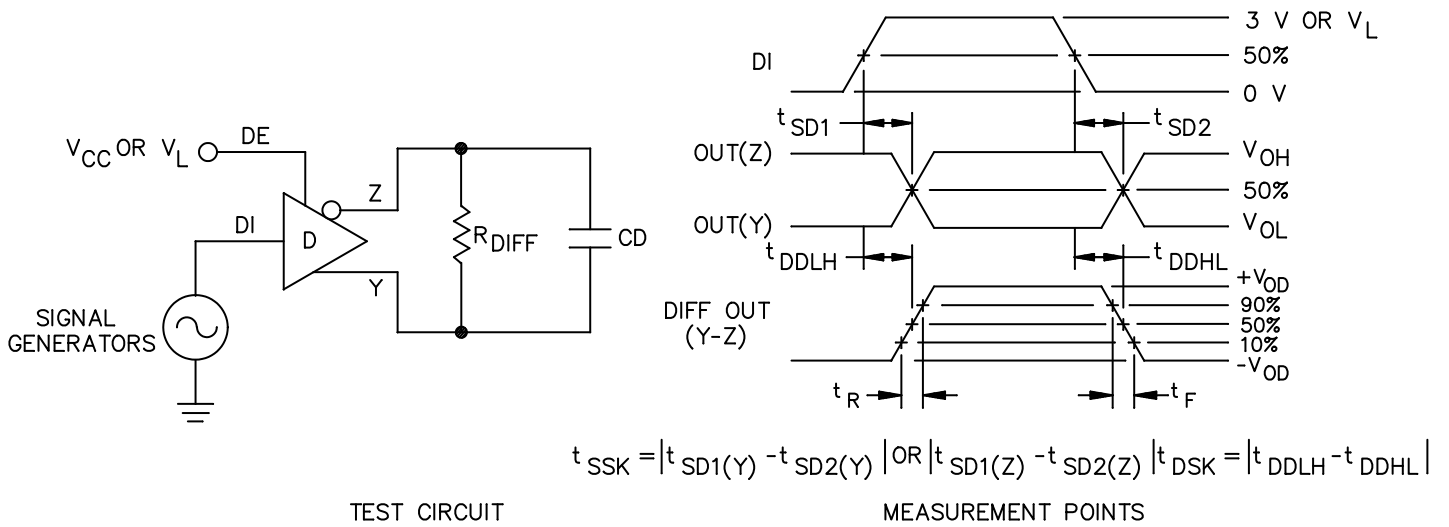
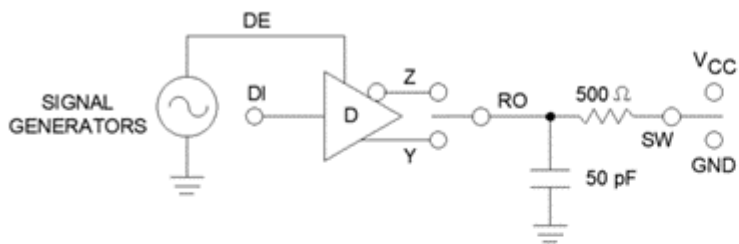


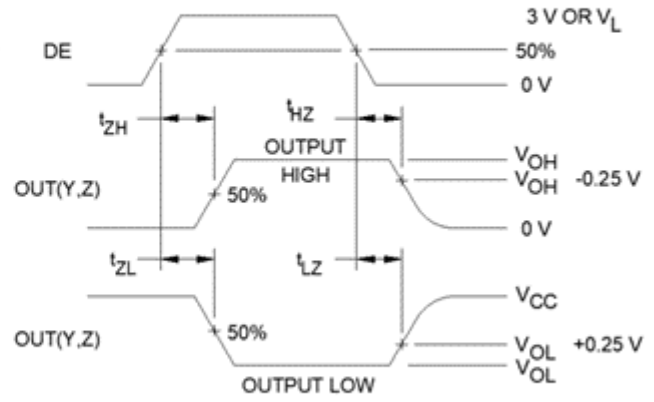
FIGURE 6. Driver propagation delay and differential transition times.

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PARAMETER	OUTPUT	DI	SW
t_{HZ}	Y/Z	1/0	GND
t_{LZ}	Y/Z	0/1	V_{CC}
t_{ZH}	Y/Z	1/0	GND
t_{ZL}	Y/Z	0/1	V_{CC}

TEST CIRCUIT



MEASUREMENT POINTS

FIGURE 7. Driver enable and disable times.

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4. VERIFICATION

4.1 Product assurance requirements. The manufacturer is responsible for performing all inspection and test requirements as indicated in their internal documentation. Such procedures should include proper handling of electrostatic sensitive devices, classification, packaging, and labeling of moisture sensitive devices, as applicable.

5. PREPARATION FOR DELIVERY

5.1 Packaging. Preservation, packaging, labeling, and marking shall be in accordance with the manufacturer’s standard commercial practices for electrostatic discharge sensitive devices.

6. NOTES

6.1 ESDS. Devices are electrostatic discharge sensitive and are classified as ESDS class 1 minimum.

6.2 Configuration control. The data contained herein is based on the salient characteristics of the device manufacturer’s data book. The device manufacturer reserves the right to make changes without notice. This drawing will be modified as changes are provided.

6.3 Suggested source(s) of supply. Identification of the suggested source(s) of supply herein is not to be construed as a guarantee of present or continued availability as a source of supply for the item. DLA Land and Maritime maintains an online database of all current sources of supply at <https://landandmaritimeapps.dla.mil/programs/smcr/>.

Vendor item drawing administrative control number <u>1/</u>	Device manufacturer CAGE code	Top side marking	Vendor part number <u>2/</u>
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1/ The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation.

2/ “-TK” suffix for tape and reel.

CAGE code

34371

Source of supply

Renesas Electronics America, Inc.
1650 Robert J. Conlan Blvd. NE
Palm Bay, FL 32905-3406

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